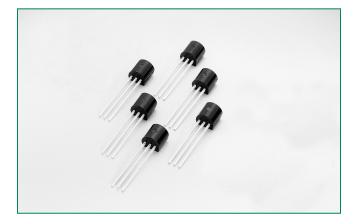
S8X5ECS

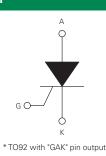
E RoHS



Main Features

Symbol	Value	Unit
I _{T(RMS)}	0.5	А
$V_{\rm drm}/V_{\rm rrm}$	800	V
$V_{\rm DSM}$ (t _p = 50 µs)	1250	V
$V_{RSM}(t_p = 50 \ \mu s)$	900	V
I _{GT}	20 to 100	μA

Schematic Symbol



Absolute Maximum Ratings

Symbol	Parameter			Value	Unit
I _{T(RMS)}	RMS on-state current (full sine wave)		$T_c = 85^{\circ}C$	0.5	A
I _{T(AV)}	Average on-state current		T _c = 85°C	0.3	A
	Non repetitive surge peak on-state current		F= 50Hz	10	A
I _{TSM}	(Sine half wave, T_initial = 25°C)		F= 60Hz	12	A
l²t	I²t Value for fusing	t _p = 10 ms	F = 50 Hz	0.5	A ² s
di/dt	Critical rate of rise of on-state current $I_{g} = 10 \text{mA}$		T _J = 125°C	80	A/µs
I _{GM}	Peak Gate Current	t _p = 20 μs	T _J = 125°C	0.5	A
P _{G(AV)}	Average gate power dissipation		T _J = 125°C	0.2	W
T _{stg}	Storage junction temperature range	_	_	-40 to 125	°C
T	Operating junction temperature range	_	_	-40 to 125	°C

Description

The S8X5ECS offers a high static dv/dt with a low turn off (tq) time. It is specifically designed for GFCI (Ground Fault Circuit Interrupter) and AFCI (Arc Fault Circuit Interrupter), RCD (Residual Current Device) and RCBO (Residual Current Circuit Breaker with Overload Protection) applications. All SCR junctions are glass-passivated to ensure long term reliability and parametric stability.

Features

- Thru-hole packages
- Surge current capability < 20Amps
- Blocking voltage (V_{DRM} / V_{RRM}) capability - up to 800V
- Non-repetitive direct surge peak off-state voltage (V_{DSM}) up to 1200V
- Non-repetitive reverse surge peak off-state voltage (V_{RSM}) up to 1000V
- High dv/dt noise immunity
- Improved turn-off time (t_a)
- Sensitive gate for direct microprocessor interface
- Halogen free and RoHS compliant

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Thyristors

EV Series 0.5 Amp Sensitive SCRs

Electrical Characteristics (T_j = 25°C, unless otherwise specified) **Test Conditions** Symbol Description Limit Value Unit $V_{_{
m D}} = 6V$ $R_{_{
m L}} = 100 \ \Omega$ MIN. 20 μA DC Gate Trigger Current I_{GT} MAX. 100 μA $V_{_{
m D}} = 6V$ $R_{_{
m L}} = 100 \ \Omega$ V V_{gt} DC Gate Trigger Voltage MAX. 8.0 V $\mathsf{V}_{\mathsf{GRM}}$ Peak Reverse Gate Voltage $I_{\rm RG} = 10 \mu A$ MIN. 8 $R_{GK} = 1 K\Omega$ Holding Current MAX. 3 mΑ I_{H} Initial Current = 20mA $T_{J} = 125^{\circ}C$ $V_{D} = 67\% \text{ of } V_{DRM}$ Exp. Waveform Critical Rate-of-Rise of dv/dt MIN. 40 V/µs Off-State Voltage $R_{GK} = 1 k\Omega$ $V_{D} = \frac{1/2}{R_{GK}} V_{DRM}$ $R_{GK} = 1 k\Omega$ $T_{J} = 125^{\circ}C$ V_{GD} Gate Non-Trigger Voltage MIN. 0.2 V $I_{T} = 0.5A$ Turn-Off Time MAX. 35 μs tq I_G=10mA $P_{w}^{G} = 15 \mu sec$ $I_{T} = 1.6 A(pk)$ Turn-On Time TYP. 2.3 μs t_{gt}

Static Characteristics (T₁ = 25°C, unless otherwise specified)

Symbol	Description	Test Conditions	Limit	Value	Unit
V _{TM}	Peak On-State Voltage	0.5A device I_{TM} = 2.5A t_p = 380 µs	MAX.	1.4	V
V _{T0}	Threshold Voltage		MAX	1.03	V
R _D	Dynamic Resistance		MAX	106	mΩ
I _{drm} /I _{rrm}	Off-State Current, Peak Repetitive	T _J = 25°C	MAX.	3	μΑ
		T _J = 125°C	MAX.	500	μΑ

Thermal Resistances					
Symbol	Description	Test Conditions	Value	Unit	
R _{th(JC)}	Junction to case (AC)	$I_{T} = 0.8A_{(RMS)}^{1}$	35	°C/W	
R _{th(j-a)}	Junction to ambient	$I_{T} = 0.8A_{(RMS)}^{1}$	150	°C/W	

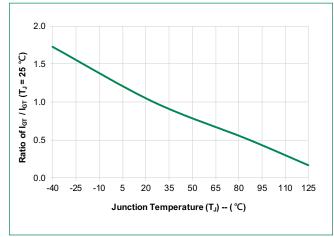
¹ 60Hz AC resistive load condition, 100% conduction.

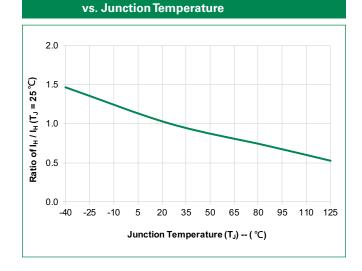
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Figure 1: Normalized DC Gate Trigger Current For All Quadrants vs. Junction Temperature





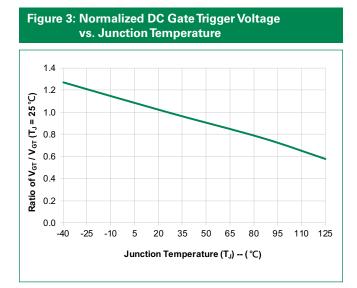
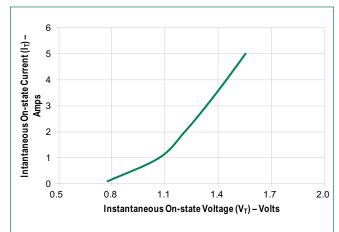


Figure 4: On-State Current vs. On-State Voltage (Typical)

Figure 2: Normalized DC Holding Current



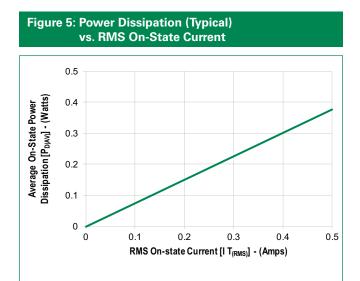
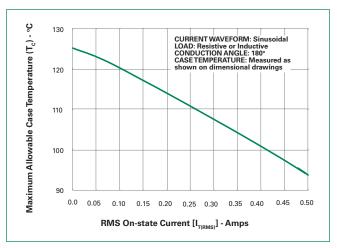


Figure 6: Maximum Allowable Case Temperature vs. On-State Current



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S8X5ECS

Thyristors EV Series 0.5 Amp Sensitive SCRs

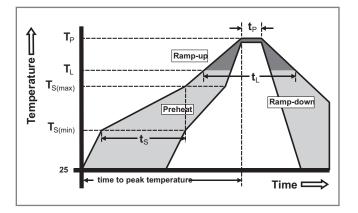
Figure 7: Surge Peak On-State Current vs. Number of Cycles



Supply Frequency: 60Hz Sinusoidal Load: Resistive RMS On-State Current [I_{T(RMS)}]: Max Rated Value at Specific Case Temperature Notes: 1. Gate control may be lost during and immediately following surge current interval. 2. Overload may not be repeated until junction temperature has returned to steady-state rated value.

Soldering Parameters

Reflow Condition		Pb – Free assembly	
	-Temperature Min (T _{s(min)})	150°C	
Pre Heat	-Temperature Max (T _{s(max)})	200°C	
	-Time (min to max) (t _s)	60 – 180 secs	
Average ra (T _L) to pea	amp up rate (LiquidusTemp) k	5°C/second max	
T _{S(max)} to T _L	- Ramp-up Rate	5°C/second max	
Reflow	-Temperature (T _L) (Liquidus)	217°C	
	-Time (min to max) (t _s)	60 – 150 seconds	
PeakTemp	erature (T _P)	260 ^{+0/-5} °C	
Time with Temperatu	in 5°C of actual peak ıre (t _p)	20 – 40 seconds	
Ramp-down Rate		5°C/second max	
Time 25°C to peak Temperature (T _P)		8 minutes Max.	
Do not exceed		280°C	



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EV Series 0.5 Amp Sensitive SCRs

Physical Specifications Terminal Finish 100% Matte Tin-plated.

Body Material	UL Recognized compound meeting flammability rating V-0.
Lead Material	Copper Alloy

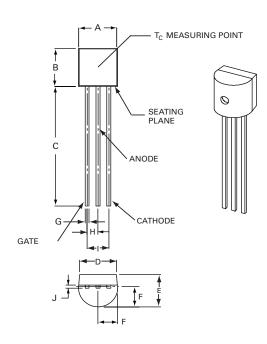
Design Considerations

Careful selection of the correct component for the application's operating parameters and environment will go a long way toward extending the operating life of the Thyristor. Good design practice should limit the maximum continuous current through the main terminals to 75% of the component rating. Other ways to ensure long life for a power discrete semiconductor are proper heat sinking and selection of voltage ratings for worst case conditions. Overheating, overvoltage (including dv/dt), and surge currents are the main killers of semiconductors. Correct mounting, soldering, and forming of the leads also help protect against component damage.

Reliability/Environmental Tests

Test	Specifications and Conditions
AC Blocking	MIL-STD-750, M-1040, Cond A Applied Peak AC voltage @ 125°C for 1008 hours
Temperature Cycling	MIL-STD-750, M-1051, 1000 cycles; -55°C to +150°C; 15-min dwell-time
Temperature/ Humidity	EIA / JEDEC, JESD22-A101 1008 hours; 320V - DC: 85°C; 85% rel humidity
UHAST	JESD22-A118, 96 hours, 130°C, 85%RH
High Temp Storage	MIL-STD-750, M-1031, 1008 hours; 150°C
Low-Temp Storage	1008 hours; -40°C
Resistance to Solder Heat	MIL-STD-750 Method 2031
Solderability	ANSI/J-STD-002, category 3, Test A
Lead Bend	MIL-STD-750, M-2036 Cond E

Dimensions – TO-92



Dimension	Inches		Millimeters	
Dimension	Min	Max	Min	Max
А	0.175	0.205	4.450	5.200
В	0.170	0.210	4.320	5.330
С	0.500		12.70	
D	0.135		3.430	
Е	0.125	0.165	3.180	4.190
F	0.080	0.105	2.040	2.660
G	0.016	0.021	0.407	0.533
Н	0.045	0.055	1.150	1.390
I	0.095	0.105	2.420	2.660
J	0.015	0.020	0.380	0.500

Packing Option

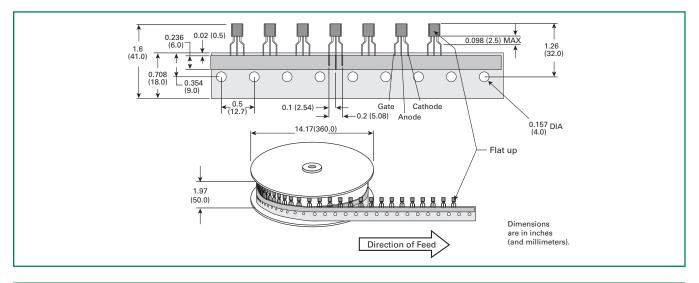
Part Number	Marking	Weight	Packing Mode	Base Quantity
S8X5ECS	S8X5ECS	0.217G	Bulk	2500
S8X5ECSRP	S8X5ECS	0.217G	Tape & Reel	2000
S8X5ECSAP	S8X5ECS	0.217G	Ammo Pack	2000

Thyristors

EV Series 0.5 Amp Sensitive SCRs

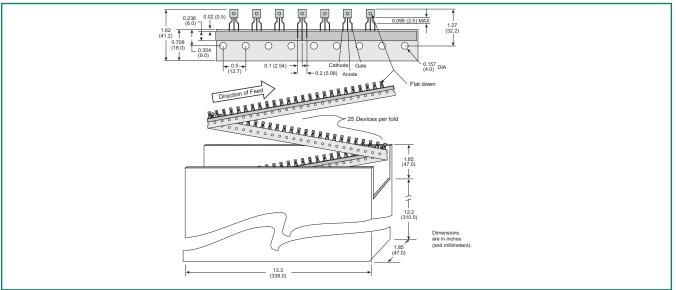
TO-92 (3-lead) Reel Pack (RP) Radial Leaded Specifications

Meets all EIA-468-C Standards

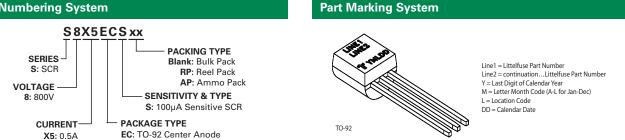


TO-92 (3-lead) Ammo Pack (AP) Radial Leaded Specifications

Meets all EIA-468-C Standards



Part Numbering System



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